

UNC-SMD Series

Feature

- Approximately zero leaking current before clamping voltage
- ◆ Less decay at on/off state.
- High capability to withstand repeated lightning strikes.
- lackbox Low electrode capacitance(\leq 0.8pF) and high isolation(\geq 100M Ω).
- RoHS compliant.
- Bilateral symmetrical.
- ◆ Temperature, humidity and lightness insensitive.
- ◆ Operating temperature: -40 ~ +85 °C °C
- Storage temperature: -40°C ~ +125°C
- ♦ Meets MSL level 1, per J-STD-020



Applications

- Power Supplies
- Motor sparks eliminating
- Relay switching spark absorbing
- Data line pulse guarding
- ♦ Electronic devices requiring UL497A and UL497B compliant
- ◆ Telephone/Fax/Modem
- High frequency signal transmitters/receivers
- Satellite antenna
- ◆ Radio amplifiers
- ◆ Alarm systems
- ◆ Cathode ray tubes in Monitors/TVs

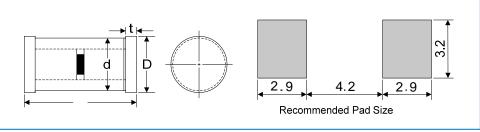
Part Numbering

UNC - 201 M - SMD

(1) (2) (3) (4)

- (1) Series
- (2) V_S Voltage, e.g. 201=20X10 1 =200V
- (3) Vs Voltage tolerance: L \pm 15%, M \pm 20%, N \pm 30%
- (4) Surface mount devices

Dimensions



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Symbol	Dimension (mm)		
L	6.0±0.5		
D	Φ 3.3 \pm 0.5 Φ 3.1 \pm 0.5 $0.4 \pm$ 0.1		
d			
Т			

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Electrical Characteristics (@ 25℃ Unless Otherwise Specified)

Part Number	DC Spark-over Voltage	Minimum Insulation Resistance		Maximum Capacitance (1KHz-6V MAX)	Surge Current Capacity
	Vs(V)	Test Voltage(V)	IR _{OHM} (MΩ)	C(pf)	(8/20 µ S)
UNC-141N-SMD	140	50	100	0.8	3000A
UNC-201M-SMD	200	100	100	0.8	3000A
UNC-301M-SMD	300	100	100	0.8	3000A
UNC-401M-SMD	400	250	100	0.8	3000A
UNC-501M-SMD	500	250	100	0.8	3000A
UNC-701M-SMD	700	250	100	0.8	3000A
UNC-102M-SMD	1000	250	100	0.8	3000A

Test Methods and Results

Items	Test Method	Standard		
DC Spark-over Voltage	Measure starting discharge voltage (Vs) by gradually increasing applied DC voltage. Test current is 0.5mA max. And the DC voltage ascends up within 100V/s(Vs<1000V) or 500V/s(Vs≥1000V).			
Insulation Resistance	Measure the insulation resistance across the terminal at regular voltage. But the test voltage doesn't over the DC spark-over voltage. Measure the electrostatic capacitance by applying a voltage of less			
Capacitance	than 6V (at 1KHz) between terminals.	Rate-of-change, within		
Static Life	10KV with 1500pf condenser is discharged through 0Ω resistor. 200 times at an interval of 10sec.	±30% insulation resistance & capacitance, conformed to rated spec.		
Surge Current	1.2/50 μ s & 8/20 μ s, 3000A, electrically connected with a resistor	No crack and no failures		
Capacity	$(2\sim4\Omega),~\pm5$ times, each time interval 60 seconds. Thereafter, outer appearance shall be visually examined.			
Cold Resistance	Measurement after -40 ℃/1000 HRS & normal temperature/2 HRS.			
Heat Resistance	Measurement after 125°C/1000 HRS & normal temperature/2 HRS.			
Humidity Resistance	Measurement after humidity 90~95°C(45°C) /1000 HRS & normal temperature/2 HRS.	Features are conformed to rated spec.		
Temperature Cycle	10 times repetition of cycle -40 °C/30min →normal, temp/2 min →125 °C/30min, measurement after normal temp/2 HRS.			
Solder Ability	older Ability Apply flux and immerse in molten solder 230±5℃ for 3sec up to the point of 1.5mm from body. Check for solder adhesion.			
Solder Heat	Measurement after lead wire is dipped up to the point of 1.5mm from body into 260±5℃ solder for 10sec.	Conformed to rated spec.		

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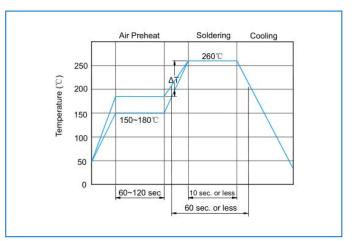
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Recommended Soldering Conditions

Flow Soldering Conditions

Air Preheat Soldering Cooling 250 250 200 150 150 150 60~120 sec 3~4 sec

Reflow Soldering Conditions



- 1) Time shown in the above figures is measured from the point when chip surface reaches temperature.
- 3) After soldering, do not force cool, allow the parts to cool gradually.

Hand Soldering

Solder iron temperature: $350\pm5\,^{\circ}$ C Heating time: 3 seconds max.

General attention to soldering

- ♦ High soldering temperatures and long soldering times can cause leaching of the termination, decrease in adherence strength, and the change of characteristic may occur.
- ◆ For soldering, please refer to the soldering curves above. However, please keep exposures to temperatures exceeding 200 ℃ to fewer than 50 seconds.
- ◆ Please use a mild flux (containing less than 0.2wt% CI). Also, if the flux is water soluble, be sure to wash thoroughly to remove any residue from the underside of components that could affect resistance.

Cleaning

When using ultrasonic cleaning, the board may resonate if the output power is too high. Since this vibration can cause cracking or a decrease in the adherence of the termination, we recommend that you use the conditions below:

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Frequency: 40kHz max.

Output power: 20W/liter

Cleaning time: 5 minutes max.



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Package Outline & Dimensions

